

• General Description

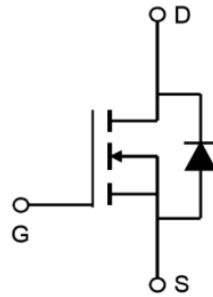
AP2308A combines advanced MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. This device is most suitable to load-switch or PWM applications.

• Applications

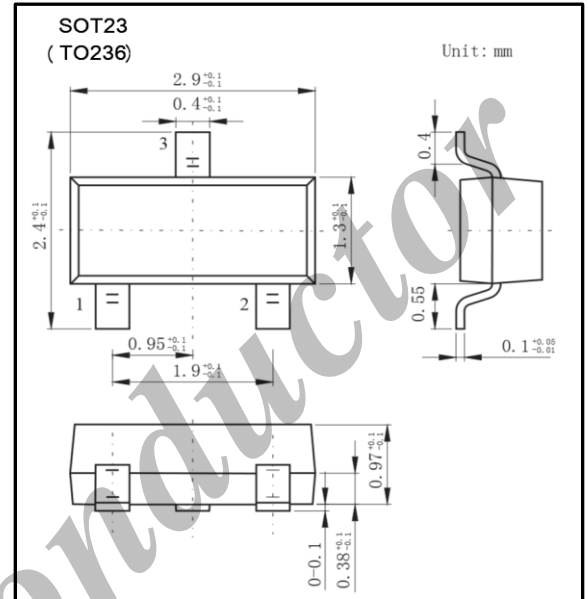
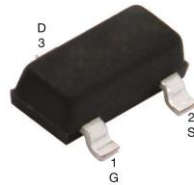
- DC/DC converter for portable devices
- Load switch

• Product Summary

V_{DS}	60V
$R_{DS(ON)}$ (at $V_{GS} = 10V$, $I_D = 2.0A$)	< 160m Ω
$R_{DS(ON)}$ (at $V_{GS} = 4.5V$, $I_D = 1.7A$)	< 220m Ω



Top View



• Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$ unless noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ^{*b}	I_D ($T_a = 25^\circ\text{C}$)	2.0	A
	I_D ($T_a = 70^\circ\text{C}$)	1.6	
Pulsed Drain Current ^{*a}	I_{DM}	10	
Continuous Source Current (Diode Conduction) ^{*b}	I_S	1.0	W
Power Dissipation ^{*b}	P_D ($T_a = 25^\circ\text{C}$)	1.25	
	P_D ($T_a = 70^\circ\text{C}$)	0.8	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$ ($t \leq 5s$) ^{*b}	100	$^\circ\text{C}/\text{W}$
	$R_{\theta JA}$ (Steady State) ^{*c}	166	
Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 to 150	

Notes

- *a Pulse width limited by maximum junction temperature
- *b Surface Mounted on FR4 Board, $t \leq 5s$.
- *c Surface Mounted on FR4 Board.

• **Electrical Characteristics (Ta = 25°C unless noted)**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V_{DSS}	$I_D=250\mu A, V_{GS}=0V$	60			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=60V, V_{GS}=0V$			0.5	μA
		$V_{DS}=60V, V_{GS}=0V, T_J=55^\circ C$			10	
Gate-Body Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.5		3	V
On-state Drain Current *d	$I_{D(ON)}$	$V_{DS}\geq 4.5V, V_{GS}=10V$	6			A
		$V_{DS}\geq 4.5V, V_{GS}=4.5V$	4			
Static Drain-Source On-Resistance *d	$R_{DS(ON)}$	$V_{GS}=10V, I_D=2.0A$			160	m Ω
		$V_{GS}=4.5V, I_D=1.7A$			220	
Forward Transconductance *d	g_{FS}	$V_{DS}=4.5V, I_D=2.0A$		4.6		S
Diode Forward Voltage *d	V_{SD}	$I_S=1A, V_{GS}=0V$			1.2	V
Input Capacitance	C_{iss}	$V_{GS}=0V, V_{DS}=25V, f=1MHz$		240		pF
Output Capacitance	C_{oss}			50		
Reverse Transfer Capacitance	C_{rss}			15		
Total Gate Charge	Q_g	$V_{GS}=10V, V_{DS}=30V, I_D=2A$		4.8	10	nC
Gate Source Charge	Q_{gs}			0.8		
Gate Drain Charge	Q_{gd}			1		
Gate Resistance	R_g		0.5		3.3	Ω
Turn-On Delay Time	$t_{D(on)}$	$V_{GEN}=4.5V, V_{DD}=30V, I_D=1A, R_L=30\Omega, R_g=6\Omega$		7	15	ns
Turn-On Rise Time	t_r			10	20	
Turn-Off Delay Time	$t_{D(off)}$			17	35	
Turn-Off Fall Time	t_f			6	15	

Note

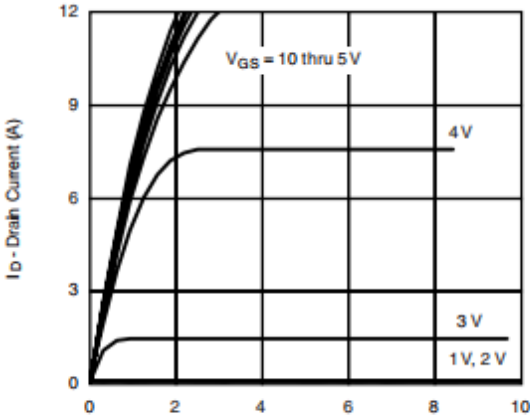
*d Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$

• **Ordering Information**

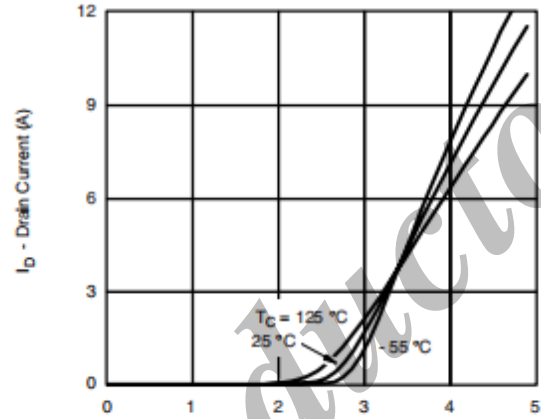
Ordering Part Number	Package	MOQ
AP2308A	SOT23 (TO236)	3,000 pcs / reel

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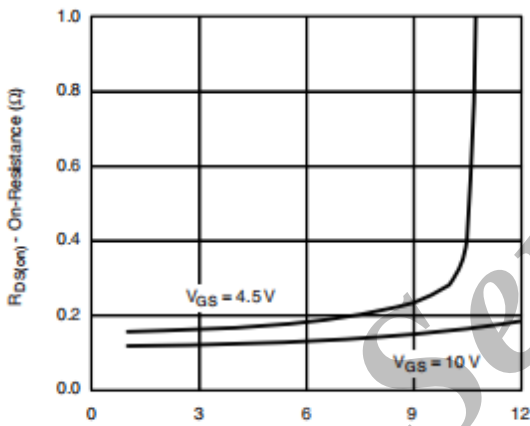
• Typical Characteristics (25°C unless noted)



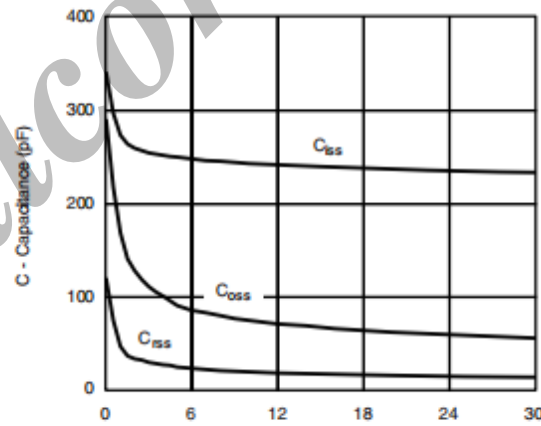
$V_{GS} = 10$ thru $5V$
 I_D - Drain Current (A)
 V_{DS} - Drain-to-Source Voltage (V)
Output Characteristics



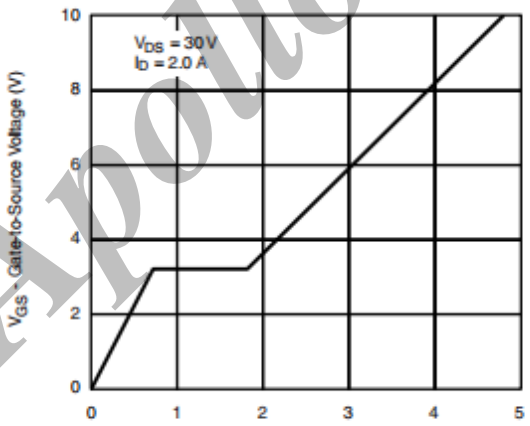
$T_C = 125^\circ C$
 $25^\circ C$
 $-55^\circ C$
 I_D - Drain Current (A)
 V_{GS} - Gate-to-Source Voltage (V)
Transfer Characteristics



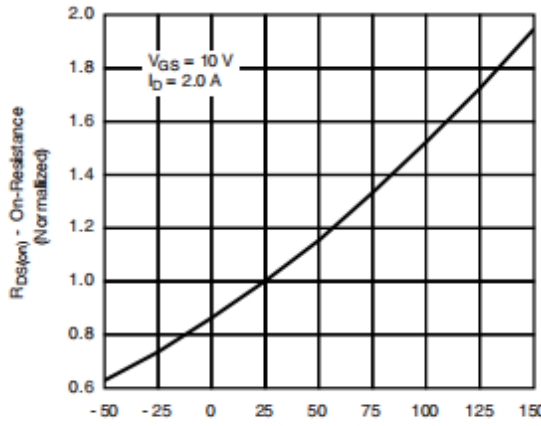
$R_{DS(on)}$ - On-Resistance (Ω)
 I_D - Drain Current (A)
 $V_{GS} = 4.5V$
 $V_{GS} = 10V$
On-Resistance vs. Drain Current



C_{iss}
 C_{oss}
 C_{rss}
 C - Capacitance (pF)
 V_{DS} - Drain-to-Source Voltage (V)
Capacitance

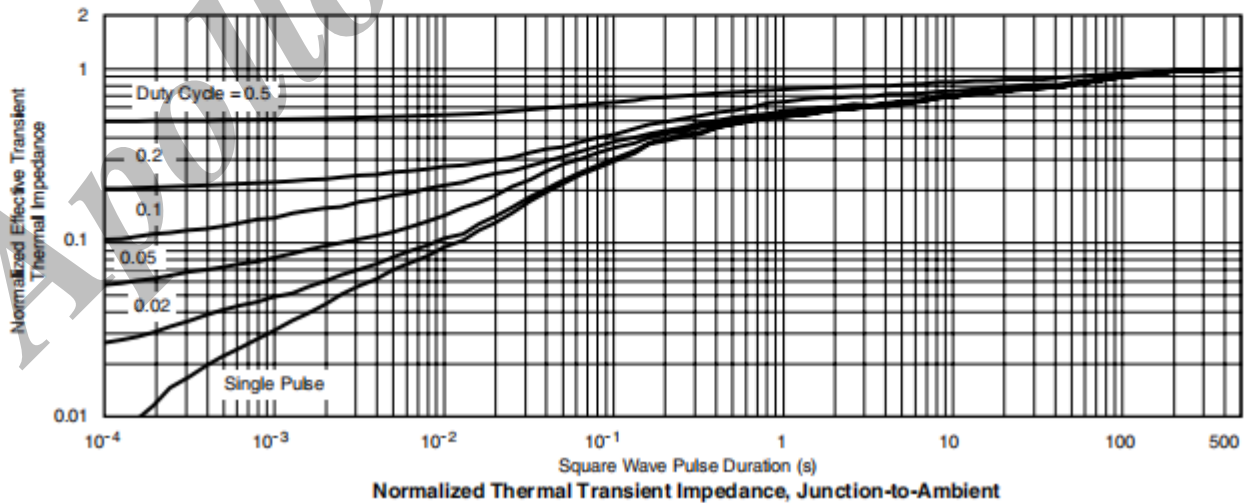
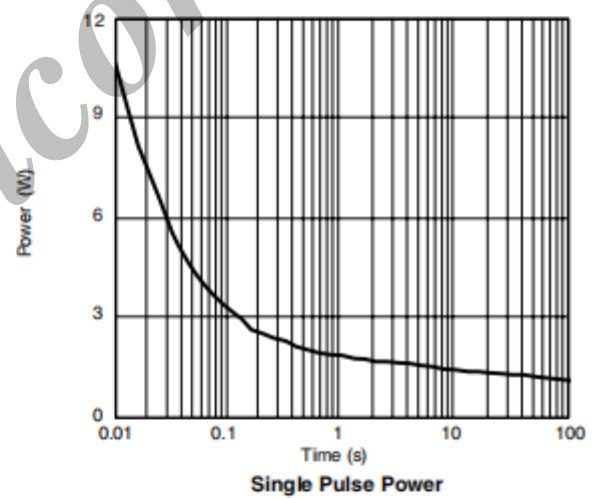
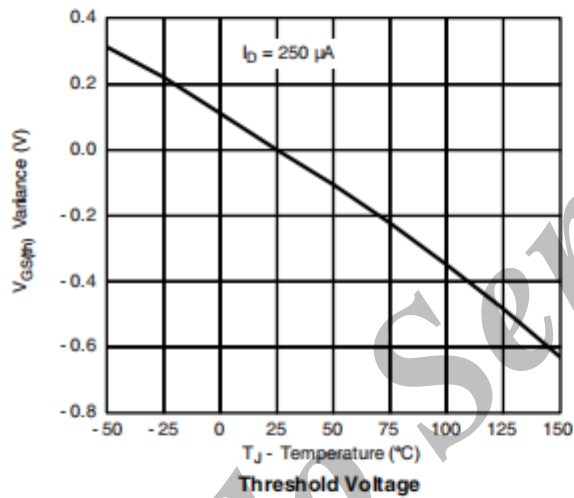
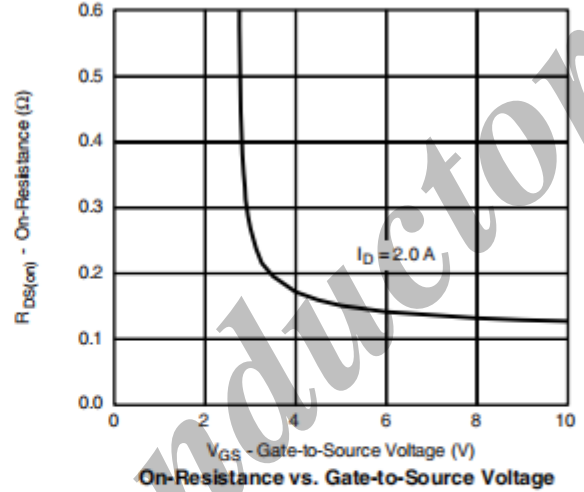
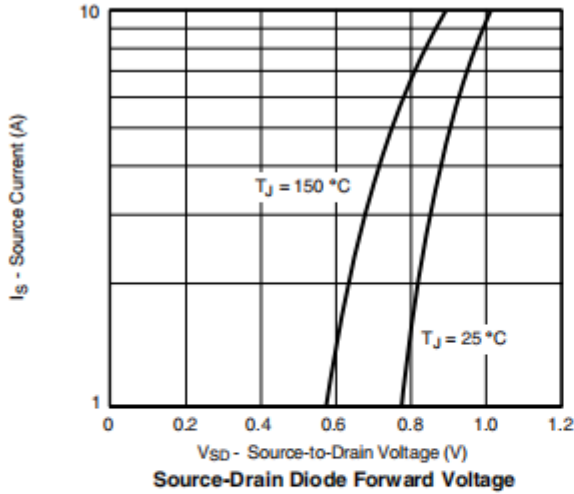


$V_{GS} = 30V$
 $I_D = 2.0A$
 V_{GS} - Gate-to-Source Voltage (V)
 Q_g - Total Gate Charge (nC)
Gate Charge



$V_{GS} = 10V$
 $I_D = 2.0A$
 $R_{DS(on)}$ - On-Resistance (Normalized)
 T_J - Junction Temperature ($^\circ C$)
On-Resistance vs. Junction Temperature

• Typical Characteristics (25°C unless noted)



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